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# **Green Commodity Thick Film Chip Resistors**



## FEATURES

- High volume product suitable for commercial applications
- Green resistor does not use exemptions
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



FREE <u>GREEN</u> (5-2008)

TECHNICAL SPECIFICATIONS					
DESCRIPTION		RCG0201C e3			
Imperial size		0201			
Metric size code		RR0603M			
Resistance range		15 Ω to 1 MΩ; jumper (0 Ω)			
Resistance tolerance		± 5 %; ± 1 %			
Temperature coefficient		± 250 ppm/K			
Rated dissipation, P <sub>70</sub> <sup>(1)</sup>		0.05 W			
Operating voltage, Umax. ACRMS/DC		25 V			
Permissible film temperature, $\mathcal{P}_{F max.}$ <sup>(1)</sup>		125 °C			
Operating temperature range		-55 °C to +125 °C			
Max. resistance change at $P_{70}$ for resistance range, $ \Delta R/R $ after:					
	1000 h	≤ <b>3.0</b> %			
Permissible voltage against ambient (insulation):					
	1 min, U <sub>ins</sub>	50 V			

#### Note

<sup>(1)</sup> Please refer to APPLICATION INFORMATION below

## **APPLICATION INFORMATION**

When the resistor dissipates power, a temperature rise above the ambient temperature occurs, dependent on the thermal resistance of the assembled resistor together with the printed circuit board. The rated dissipation applies only if the permitted film temperature is not exceeded.

These resistors do not feature a limited lifetime when operated within the permissible limits. However, resistance value drift increasing over operating time may result in exceeding a limit acceptable to the specific application, thereby establishing a functional lifetime.

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE						
TYPE / SIZE TCR TOLERANCE RESISTANCE E-SERIES						
RCG0201C e3	± 250 ppm/K	± 5 %	15 $\Omega$ to 1 M $\Omega$	E24		
		±1%	15 $\Omega$ to 1 M $\Omega$	E24; E96		
	Jumper, I <sub>max.</sub> = 0.5 A	$\leq$ 50 m $\Omega$	0 Ω	-		

Note

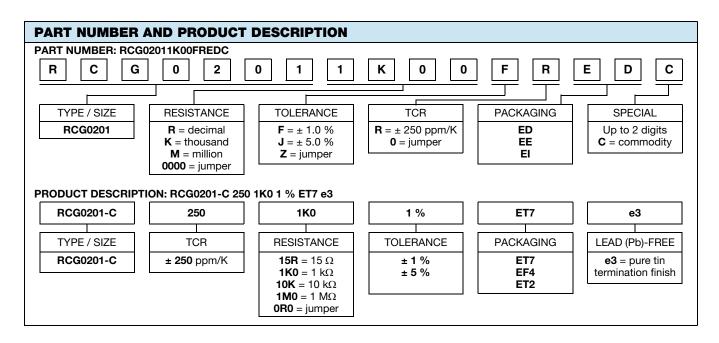
• The temperature coefficient of resistance (TCR) is not specified for 0  $\Omega$  jumpers

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# RCG0201...C e3

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PACKAGING								
TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	PACKAGING DIMENSIONS		
RCG0201C e3	ED = ET7	10 000	Paper tape acc. to IEC 60068-3 Type I			Ø 180 mm/7"		
	EI = ET2	20 000		to IEC 60068-3	to IEC 60068-3	8 mm	2 mm	Ø 254 mm/10"
	EE = EF4	50 000				Ø 330 mm/13"		



VISHAY GREEN REQUIREMENTS				
SUBSTANCES	CONCENTRATION LIMIT			
Lead (Pb)	< 1000 ppm			
Mercury (Hg)	< 1000 ppm			
Cadmium (Cd)	< 100 ppm			
Hexavalent chronium	< 1000 ppm			
Polybrominated biphenyl (PBB)	< 1000 ppm			
Polybrominated diphenyl ether (PBDE)	< 1000 ppm			
Bromine (Br)	< 900 ppm			
Chlorine (Cl)	< 900 ppm			
Sum of bromine and chlorine	≤ 1500 ppm max.			
Antimony (Sb)	< 900 ppm			
Red phosphorous	< 100 ppm			

#### Notes

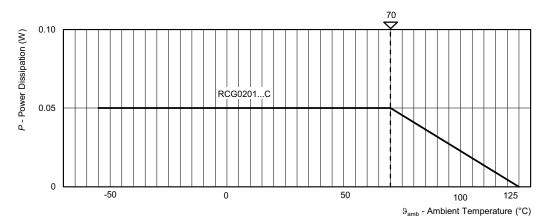
• No exemptions (e.g. lead (Pb) in glass) may be applied to any substances or application for the "Vishay Green" category

· All concentration levels are based on homogenous materials



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DERATING



TEST PROCEDURES AND REQUIREMENTS						
EN 60115-1 CLAUSE	IEC 60068-2 <sup>(1)</sup> TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE ( <i>AR</i> )		
			Stability for product types:	15 $\Omega$ to 1 M $\Omega$		
			RCG0201C e3	10 32 10	J 1 10122	
4.5	-	Resistance	-	±1%	± 5 %	
4.8	-	Temperature coefficient	(20 / -55 / 20) °C and (20 / 125 / 20) °C	± 250	opm/K	
4.25.1	-	Endurance at 70 °C	$U = \sqrt{P_{70} \times R} \text{ or } U = U_{\text{max.}};$ ; whichever is less; 1.5 h on; 0.5 h off; 70 °C; 1000 h	± (3 % R	+ 0.1 Ω)	
4.25.3	-	Endurance at upper category temperature	125 °C, 1000 h	± (2 % <i>R</i>	+ 0.1 Ω)	
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; (93 ± 3) % RH; 56 days	± (3 % <i>R</i> + 0.1 Ω)		
4.36	1 (Aa)	Operation at low temperature	-55 °C; 1 h	$\pm$ (1 % R + 0.05 Ω)		
4.19	14 (Na)	Rapid change of temperature	30 min. at -55 °C; 30 min. at 125 °C 5 cycles 300 cycles	$\pm$ (0.5 % R + 0.05 Ω) $\pm$ (1 % R + 0.05 Ω)		
4.13	-	Short time overload	$U = 2.5 \times \sqrt{P_{70} \times R} \le 2 \times U_{\text{max.}};$ whichever is the less severe; 5 s	± (2 % <i>R</i> + 0.1 Ω)		
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude $\leq$ 1.5 mm or $\leq$ 200 m/s <sup>2</sup> ; 7.5 h	$\pm$ (0.5 % R + 0.05 Ω)		
4.17	58 (Td)	Solderability	Solder bath method; Sn60Pb40 non-activated flux; $(235 \pm 5)$ °C $(2 \pm 0.2)$ s Solder bath method; Sn96.5Ag3Cu0.5 non-activated flux; $(245 \pm 5)$ °C $(3 \pm 0.3)$ s	Good tinning (≥ 95 % covered) no visible damage		

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3 For technical questions, contact: <u>thickfilmchip@vishay.com</u> Document Number: 20068

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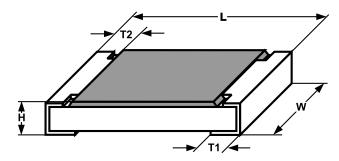
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TEST PROCEDURES AND REQUIREMENTS					
EN 60115-1 CLAUSE	IEC 60068-2 <sup>(1)</sup> TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE (∆ <i>R</i> )	
			Stability for product types:	15 Ω to 1 MΩ	
			RCG0201C e3	13 22 10 1 10122	
4.18	58 (Td)	Resistance to soldering heat	Solder bath method (260 ± 5) °C; (10 ± 1) s	± (1.0 % <i>R</i> + 0.05 Ω)	
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage	
4.32	21 (Uu <sub>3</sub> )	Shear (adhesion) test	RR0603M: 3 N	No visible damage	
4.33			Depth 2 mm;	± (1 % <i>R</i> + 0.05 Ω)	
4.00	21 (Uu <sub>1</sub> )	Substrate bending	3 times	No visible damage, no open circuit in bent position	
4.7	-	Voltage proof	$U = 1.4 \times U_{ins}; 60 s$	No flashover or breakdown	

#### Note

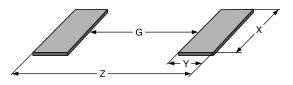
<sup>(1)</sup> The quoted IEC standards are also released as EN standards with the same number and identical contents

#### **DIMENSIONS** in millimeters



DIMENSIONS AND MASS							
TYPE / SIZE	TYPE / SIZE L W H T1 T2 MASS   (mm) (mm) (mm) (mm) (mm) (mg)						
RCG0201C e3	$0.60 \pm 0.05$	$0.30 \pm 0.05$	$0.23 \pm 0.05$	0.15 ± 0.05	0.10 ± 0.05	0.17	

### SOLDER PAD DIMENSIONS



RECOMMENDED SOLDER PAD DIMENSIONS							
	REFLOW SOLDERING						
TYPE / SIZE	G	Y	Х	Z			
	(mm) (mm) (mm) (mm)						
RCG0201C e3	0.3 0.35 0.4 1.0						

#### Notes

 The given solder pad dimensions reflect the considerations for board design and assembly as outlined e.g in standards IEC 61188-5-x <sup>(1)</sup> or in publication IPC-7351

<sup>(1)</sup> The quoted IEC standards are also released as EN standards with the same number and identical contents

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